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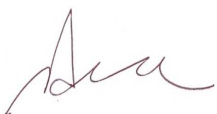
NO. : M160405



APPROVAL SHEET

ITEM : MONOLITHIC MULTILAYER
CERAMIC CAPACITOR
(Thin Layer Large-Capacitance Type)

Approved by customer : (signing or stamping here)

SAMWHA CAPACITOR CO., LTD.		
Writtern by	Checked by	Approved by
		

2016. 04. 05.

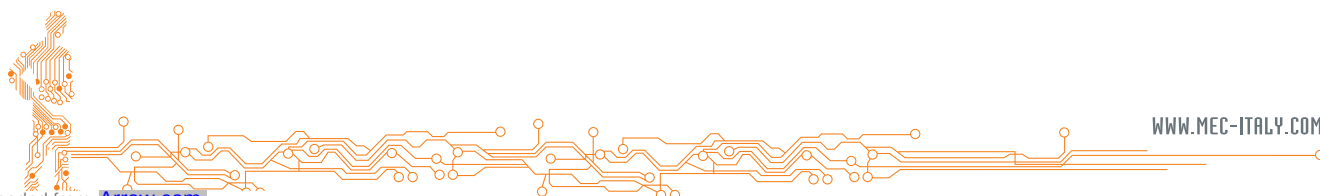


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< SPEC SUMMARY >

SPEC.	CS3225X7R226K250NRL		
Type	Thin Layer Large-Capacitance		
Item	Specification	Unit	Test methods and Conditions(Capacitance,IR)
Capacitance	22	μF	Testing Frequency : 120 $\pm$ 24Hz Testing Voltage : 0.5 $\pm$ 0.1Vrms
Capacitance Tolerance	± 10	%	
Dissipation Factor	Max. 12.5	%	
Insulation Resistance	More than 2.27	M Ω	Applied the rated voltage for 2 minutes of charging.
Chip Size	3.20 $\pm$ 0.40	L (mm)	*Capacitance Tolerance Code ---- page 1/8
	2.50 $\pm$ 0.25	W (mm)	*Chip size ----- page 2/8
	2.50 $\pm$ 0.25	T (mm)	*Characteristics & Test Method----- page 3/8~5/8

Enactment : March 27,1996	STANDARD	NO	SW - M - 04B
	MONOLITHIC MULTILAYER CERAMIC CAPACITOR LEADLESS TYPE	Page	1 / 8

1. General Article

Application Range

These specifications refer to the "Monolithic Multilayer Ceramic Capacitors Leadless Type "mainly used to the computer equipment, communication equipment, industrial electronic appliances.

2. General Code

(1) Type Designation

CS	3225	X7R	226	K	250	N	R	L
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)

1) Monolithic Multilayer Ceramic Capacitor Leadless Type

2) Size Code :

This is expressed in tens of a millimeter.

The first two digits are the length, The last two digits are width.

3) Temperature Coefficient Code

Classification	Code	Temperature Range	Capacitance Tolerance
Class I	C0G	-55 to +125℃	±30 ppm/℃
Class II	X5R	-55 to +85℃	±15%
	X7R	-55 to +125℃	±15%
	Y5V	-30 to +85℃	+22% ~ -82%

4) Capacitance Code(Pico farads) :

The nominal Capacitance Value in pF is expressed by three digit numbers.

The first two digits represents significant figures and the last digit denotes the number of zero

ex) 104 = 100000 pF

R denotes decimal

8R2 = 8.2 pF

5) Capacitance Tolerance Code

Code	Tolerance
B	± 0.1 pF
C	± 0.25 pF
D	± 0.5 pF
F	± 1.0 %
G	± 2.0 %
J	± 5 %
K	± 10 %

Code	Tolerance
M	± 20 %
P	+ 100, - 0%
Z	+ 80, - 20%
H	+ 0.25/-0 pF
I	+ 0/-0.25 pF
U	+ 5/-0 %
V	+ 0/-5 %

6) Voltage Code

code	6R3	100	160	250	500	101	201	251	501	631	102	202	302
Vol.	DC 6.3V	DC 10V	DC 16V	DC 25V	DC 50V	DC 100V	DC 200V	DC 250V	DC 500V	DC 630V	DC 1KV	DC 2KV	DC 3KV

7) Termination Code

ex) N : Ni-Sn (Nickel-Tin Plate)

A : Ag/Ni-Sn (Ag Epoxy/Nickel-Tin Plate)

8) Packing Code

ex) R : Reel Type

B : Bulk Type

9) Thickness option (Cu, Ag Epoxy)

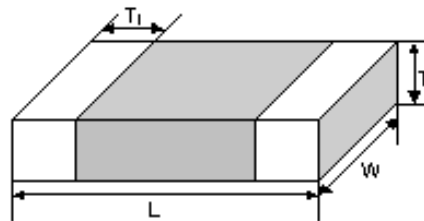
Thickness(mm)		Code	Thickness(mm)		Code
t	Tol(±)		t	Tol(±)	
0.30	0.03	Blank	1.30	0.20	E
0.50	0.05	Blank	1.35	0.20	H
0.60	0.10	A	1.60	0.20	I
0.80	0.10	B	1.80	0.20	J
0.85	0.15	B	2.00	0.25	K
1.00	0.15	E	2.50	0.25	L
1.10	0.15	E	2.80	0.30	M
1.15	0.15	E	3.20	0.30	N
1.25	0.15	E	5.00	0.40	O

3. Temperature Characteristics

See Page 5/8 (No.13)

4. Constructions and Dimensions

(1) Dimensions

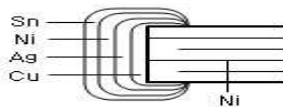


(Unit : mm)

Code	Dimension						
	Length				Width		T1(min)
	L	Cu	Ag Epoxy		Cu, Ag Epoxy		
		Tol(±)	Tol(−)	Tol(+)	W	Tol(±)	
0603	0.60	0.03	–	–	0.30	0.03	0.05
1005	1.00	0.05	0.05	0.10	0.50	0.05	0.05
1608	1.60	0.15	0.15	0.20	0.80	0.10	0.10
2012	2.00	0.20	0.20	0.30	1.25	0.15	0.10
3216	3.20	0.30	0.30	0.40	1.60	0.20	0.15
3225	3.20	0.40	0.40	0.40	2.50	0.25	0.15
4520	4.50	0.40	0.40	0.40	2.00	0.25	0.20
4532	4.50	0.40	0.40	0.40	3.20	0.30	0.20
5750	5.70	0.50	0.50	0.50	5.00	0.40	0.30

*1005 Size $\geq 4.7\mu F \Rightarrow L, W, T : Tol \pm 0.15$ *1608 Size $\geq 10\mu F \Rightarrow W : 0.80 \pm 0.15, T : 0.80 \pm 0.15$ *2012 Size $\geq 10\mu F \Rightarrow W : 1.25 \pm 0.20, T : 0.85 \pm 0.15$ *3216 Size $\geq 47\mu F \Rightarrow W : 1.60 \pm 0.30, T : 1.60 \pm 0.30$

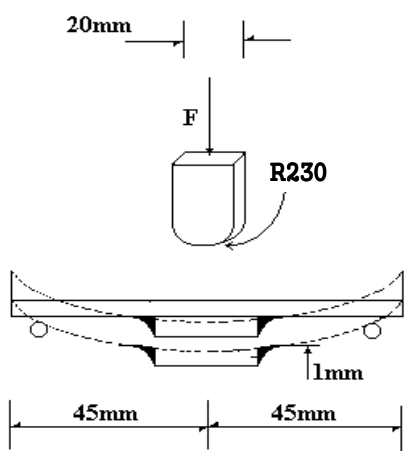
(2) Construction of Termination



(Inner Electrode : Ni Type I) (Inner Electrode : Ni Type II) (Inner Electrode : Ag/pd Type)

Specifications and Test Methods (Thin Layer Large-Capacitance Type)

No.	Item		Specification	Test Methods and Conditions															
1	Operating Temperature Range		X7R : -55 to +125℃ X5R : -55 to +85℃ Y5V : -30 to +85℃																
2	Insulation Resistance		50Ω·F min	·Applied the rated voltage for 2 minutes of charging, The charge/discharge current is less than 50mA.															
3	Dielectric Strength		No defects or abnormalities	X7R, X5R, Y5V : The rated voltage × 250% – Applied between the terminations for 1 to 5 seconds. – The charge/discharge current is less than 50mA.															
4	Capacitance		within the specified tolerance	The capacitance/D.F. should be measured at 25℃ at the frequency and voltage shown in the table. <table><tr><td>Capacitance</td><td>Frequency</td><td>Voltage</td></tr><tr><td>C≤10μF</td><td>1 ± 0.1kHz</td><td>0.5~1.0Vrms</td></tr><tr><td>C>10μF</td><td>120 ± 24Hz</td><td>0.5±0.1Vrms</td></tr></table>	Capacitance	Frequency	Voltage	C≤10μF	1 ± 0.1kHz	0.5~1.0Vrms	C>10μF	120 ± 24Hz	0.5±0.1Vrms						
Capacitance	Frequency	Voltage																	
C≤10μF	1 ± 0.1kHz	0.5~1.0Vrms																	
C>10μF	120 ± 24Hz	0.5±0.1Vrms																	
5	Dissipation Factor		X7R, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max																
6	Solderability of Termination		–Termination should be covered with more than 75% of new solder	*Pb-Free type Solder : 96.5Sn-3Ag-0.5Cu Solder temperature : 245±5℃ Immersion time : 3±0.1sec *Pre-Heating : at 80~120℃ for 10~30sec															
7	Resistance to Soldering Heat	Appearance	No marking defects	Preheat the capacitor at 120 to 150℃ for 1 minute. (Preheating for 3225,4520,4532 Step1:100℃ to 120℃, 1min Step2:170℃ to 200℃, 1min) Immerse the capacitor in a eutectic solder solution at 260±5℃ for 10±0.5 seconds. ·Initial measurement Perform the initial measurement according to Note1 for Class II ·Measurement after test Let sit at room temperature for 48±4 hours,then measure.															
		Capacitance change	X7R, X5R : Within±12.5% Y5V : Within±20%																
		Dissipation Factor	X7R, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max																
		I.R.	50Ω·F min																
8	Temperature cycle	Appearance	No marking defects	Perform the five cycles according to the four heat treatments listed in the following table. <table><tr><td>Step</td><td>1</td><td>2</td><td>3</td><td>4</td></tr><tr><td>Temp (℃)</td><td>Min. operating temp. +0/-3</td><td>Room Temp</td><td>Max. operating temp. +3/-0</td><td>Room Temp</td></tr><tr><td>Time (min)</td><td>30±3</td><td>2 to3</td><td>30±3</td><td>2 to3</td></tr></table> ·Initial measurement Perform the initial measurement according to Note1 for Class II ·Measurement after test Perform the final measurement according to Note2	Step	1	2	3	4	Temp (℃)	Min. operating temp. +0/-3	Room Temp	Max. operating temp. +3/-0	Room Temp	Time (min)	30±3	2 to3	30±3	2 to3
		Step	1		2	3	4												
		Temp (℃)	Min. operating temp. +0/-3		Room Temp	Max. operating temp. +3/-0	Room Temp												
		Time (min)	30±3		2 to3	30±3	2 to3												
Capacitance Change	X7R, X5R : Within ±7.5% Y5V : Within ±20%																		
Dissipation Factor	X7R, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max																		
I.R	50Ω·F min																		

No.	Item	Specification	Test Methods and Conditions
9	High Temperature Load	Appearance	No marking defects
		Capacitance Change	X7R, X5R : Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$
		Dissipation Factor	X7R, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max
		I.R	12.5 Ω ·F min
10	Bending strength	 No cracking or marking defects shall occur	
		Capacitance Change	X7R, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$ Within +30/-40% (cap $\geq 10\mu$ F)
11	Vibration Resistance	Appearance	No defects or abnormalities
		Capacitance	Whin the specified tolerance
		Dissipation Factor	X7R, X5R : 12.5%max *3216 Size 100 μ F : 15%max Y5V : 20%max
12	Humidity Load	Appearance	No marking defects
		Capacitance Change	X7R, X5R: Within $\pm 12.5\%$ Y5V : Within $\pm 30\%$
		Dissipation Factor	X7R, X5R : 20%max *3216 Size 100 μ F : 30%max Y5V : 40%max
		I.R.	12.5 Ω ·F min

No.	Item	Specification				Test Methods and Conditions
13	Capacitance Temperature Characteristics	Char.	Temp. Range	Reference Temp.	Cap. Change	The capacitance change should be measured after 5 min. at each specified temperature stage. The ranges of capacitance change compared with the 25°C value over the temperature ranges shown in the table should be within the specified ranges.
		X5R	-55 to +85°C	25°C	Within ±15%	
		X7R	-55 to +125°C	25°C	Within ±15%	
		Y5V	-30 to +85°C	25°C	Within +22/-82%	

*Note1. Initial Measurement for Class II

Perform a heat treatment at 150+0,-10°C for one hour and then let sit for 48±4 hours at room temperature, then measure

*Note2. Measurement after test

1. Class I

Let sit for 24±2 hours at room temperature, then measurement

2. Class II

Perform a heat treatment at 150+0,-10°C for one hour and then let sit for 48±4 hours at room temperature, then measure.

5. Packing

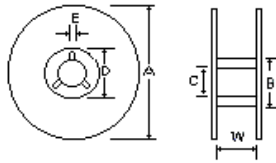
(1) Bulk packing

- ① 1000 pcs per Polybag
- ② 5 Polybags per Inner box
- ③ 10 Inner boxes per Out box

(2) Reel Packing

- ① 8~10 Reels per Inner box
- ② 6 Inner boxes per Out box

(3) Reel Dimensions



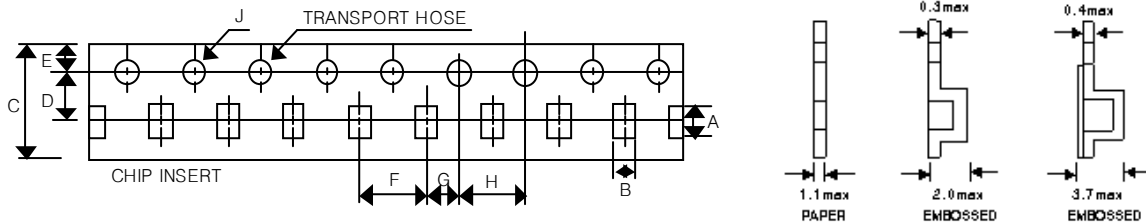
(Unit : mm)

MARK	SIZE	A	B	C	D	E	W
7 " REEL	0603~3225	$\Phi 178 \pm 2$	$\Phi 50 \text{Min}$	$\Phi 13 \pm 0.5$	$\Phi 21 \pm 0.8$	2 ± 0.5	10 ± 1.5
	4520~4532	$\Phi 180 +0, -3$	$\Phi 60 -0, +1$	$\Phi 13 \pm 0.2$	$\Phi 57 -0 +1$	3 ± 0.2	13 ± 0.5
13 " REEL	1005~3225	$\Phi 330 \pm 2$	$\Phi 70 \text{Min}$	$\Phi 13 \pm 0.5$	$\Phi 21 \pm 0.8$	2 ± 0.5	10 ± 1.5

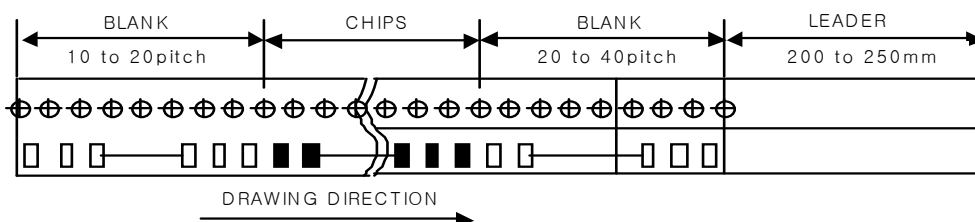
(4) Number of Package

TYPE	EIA CODE	7"	13"
		Qt/REEL	Qt/REEL
CS0603	CC0201	15,000	
CS1005	CC0402	10,000	50,000
CS1608	CC0603	4,000	16,000
CS2012	CC0805	3,000 ~ 4,000	10,000
CS3216	CC1206	2,000 ~ 4,000	6,000 ~ 10,000
CS3225	CC1210	1,000 ~ 3,000	4,000 ~ 10,000
CS4520	CC1808	1,500 ~ 3,000	-
CS4532	CC1812	500 ~ 1,000	1,500 ~ 5,000

(5) Tape Dimensions



TYPE	EIA CODE	A	B	C	D	E	F	G	H	J
CS0603	CC0201	0.67 ± 0.05	0.37 ± 0.05	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	2.0 ± 0.05	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS1005	CC0402	1.15 ± 0.1	0.65 ± 0.1	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	2.0 ± 0.05	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS1608	CC0603	1.9 ± 0.2	1.10 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS2012	CC0805	2.4 ± 0.2	1.65 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS3216	CC1206	3.6 ± 0.2	2.00 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS3225	CC1210	3.6 ± 0.2	2.80 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	4.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS4520	CC1808	4.8 ± 0.2	2.3 ± 0.2	12.0 ± 0.3	5.5 ± 0.1	1.75 ± 0.1	4.0 ± 0.1 8.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1
CS4532	CC1812	4.9 ± 0.2	3.6 ± 0.2	12.0 ± 0.3	5.5 ± 0.1	1.75 ± 0.1	8.0 ± 0.1	2.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1



6. Caution

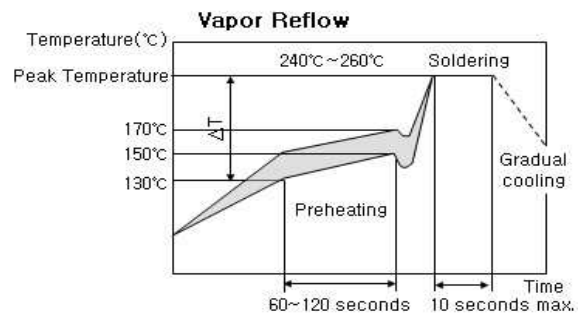
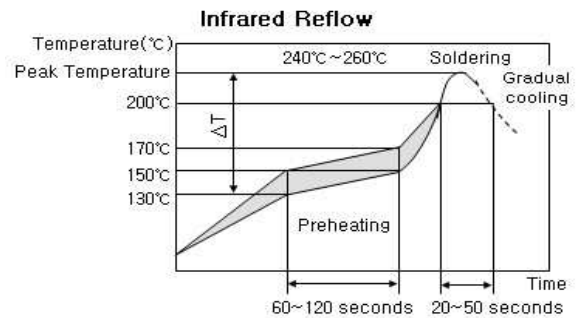
► Reflow Soldering

1. The sudden temperature change easily causes mechanical damages to ceramic components. Therefore, the preheating procedures should be required for the soldering of ceramic components.
2. Please refer to the recommended soldering profiles as shown in figures, and keep the temperature difference(ΔT) within the range recommended in Table 1.

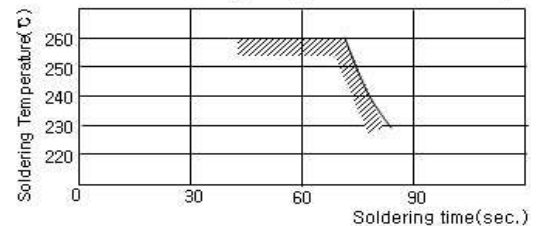
Table 1

Size code	Temperature Difference
0603, 1005, 1608, 2012, 3216	$\Delta T \leq 190^\circ\text{C}$
3225size and over	$\Delta T \leq 130^\circ\text{C}$

[Standard Conditions for Reflow Soldering]



[Allowable Soldering Temperature and Time]



In case of repeated soldering, the accumulated soldering time must be within the range shown above.

► Storage Condition

*When Solderability is considered, Capacitor are recommended to be used in 12 months

- (1) Temperature: $25^\circ\text{C} \pm 10^\circ\text{C}$
- (2) Relative Humidity: Below 70% RH

► The Regulation of Environmental Pollution Materials.

*Never use materials mentioned below in MLCC products regulated this document.

Pb, Cd, Hg, Cr^{+6} , PBB(Polybromide biphenyl), PBDE(Polybrominated diphenyl ethers), asbestos.

* Note

(1) 'Aging'/'De-aging' Behavior of high dielectric MLCCs

(Typically represented by X7R, Y5V temperature characteristic of which main composition is BaTiO₃)

'Aging' / 'De-aging' Behavior of high dielectric MLCCs Please note that high dielectric type dielectric Ceramic Capacitors have a "normal" 'aging' behavior / characteristic, that is; their capacitance value decreases with time from its value when it was first manufactured. From that date, the capacitance value begins to decrease at a logarithmic rate defined by:

$$C_t = C_{48} (1 - k \log_{10} t)$$

where :

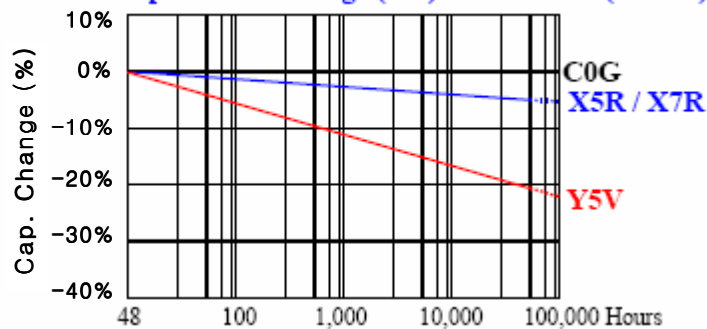
C_t = Capacitance Value, t hours after the start of 'aging'

C_{48} = Capacitance Value, 48 hours after its manufacture

k = aging constant (capacitance decrease per decade-hour)

t = time, in hours, from the start of 'aging'

Ceramic's Capacitance Change (%) versus Time (hours)



The capacitance value can be restored (a.k.a. 'de-aged') by exposing the component to elevated temperatures approaching its Curie Temperature (approximately 120°C). This 'deaging' can occur during the component's solder-assembly onto the PCB, during life or temperature cycle testing., or by ' baking ' at 150°C for about 1 hour.

Dielectric	Maximum Percent Capacitance Loss per Decade hour, k
C0G	0
X5R/X7R	~3%
Y5V	~8%